#### T-1 3/4(5mm) BLINKING LED LAMP

Part Number: WP56BHD

Bright Red

#### **Features** Description • T-1 3/4 package. The Bright Red source color devices are made with Gallium • With built-in blinking IC. Phosphide Red Light Emitting Diode. • Operation voltage from 3.5V to 14V. • Blinking frequency from 3.0Hz to 1.5Hz. • RoHS compliant. **Package Dimensions** 8.6(0.339) 25(0.984)MIN. 1(0.039) ø5.9(0.232) $1.5(0.059)\pm 1$ CATHODE ø5(0.197) 54(0. $\Box 0.5(0.02)^{+0.25}_{-0.1}$ 0.7MAX. 1.0MAX Notes: 1. All dimensions are in millimeters (inches). 2. Tolerance is ±0.25(0.01") unless otherwise noted. Lead spacing is measured where the leads emerge from the package. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

SPEC NO: DSAF2693 APPROVED: WYNEC REV NO: V.5B CHECKED: Allen Liu DATE: FEB/15/2013 DRAWN: Y.Liu

PAGE: 1 OF 6 ERP: 1101005621

Selection Guide								
Part No.	Dice	Lens Type	lv (mcd) V= 9V		Viewing Angle [1]			
			Min.	Тур.	201/2			
WP56BHD	Bright Red (GaP)	Red Diffused	1.2	4	60°			

Notes:

01/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.
Luminous intensity value is traceable to the CIE127-2007 compliant national standards.

#### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Device	Min.	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Bright Red		700		nm	
λD	Dominant Wavelength	Bright Red		635		nm	
Δλ1/2	Spectral Line Half-width	Bright Red		45		nm	
lf	Forward Current	Bright Red	8	22		mA	Min:V⊧=3.5V Typ:V⊧=5V
Ison	Supply Current	Bright Red		8		mA	VF=3.5V
Ison	Supply Current	Bright Red		44		mA	VF=14V
f	Blink Frequency	Bright Red	1.5		3	Hz	VF=3.5V~14V

Note:

1. Wavelength value is traceable to the CIE127-2007 compliant national standards.

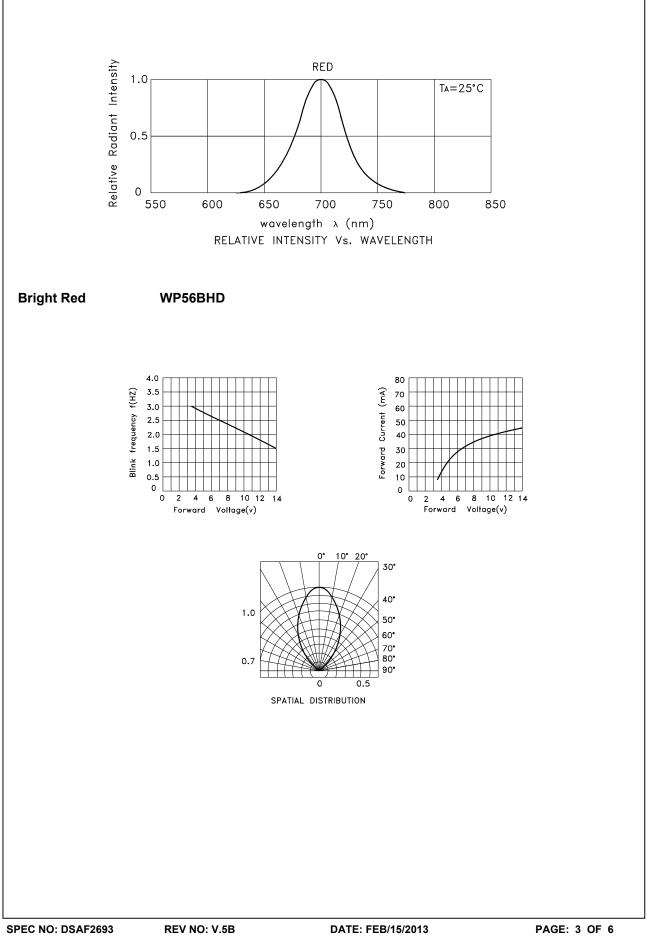
#### Absolute Maximum Ratings at TA=25°C

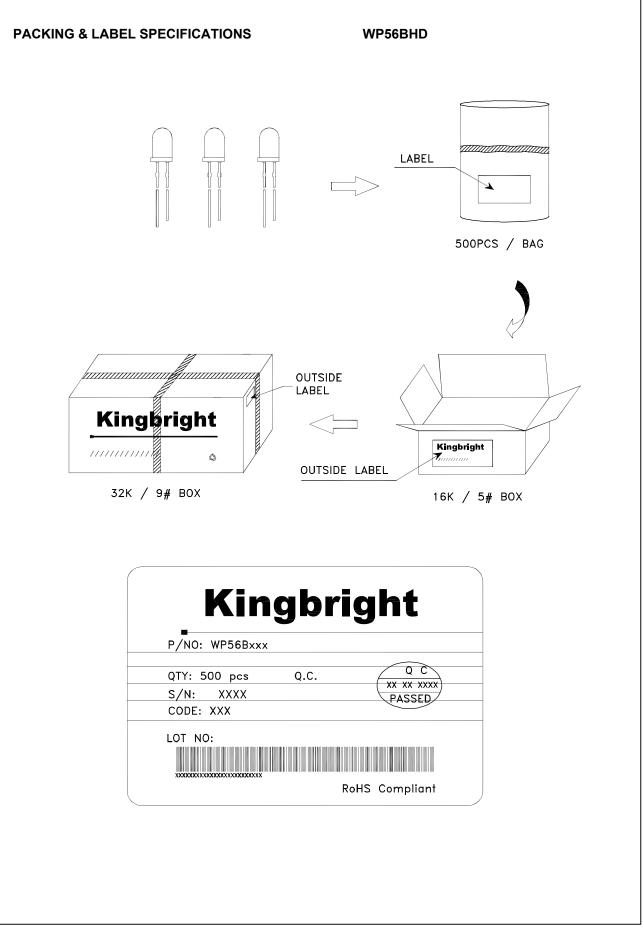
Bright Red			
310	mW		
14	V		
0.5	V		
-40°C To +70°C			
-40°C To +85°C			
260°C For 3 Seconds			
260°C For 5 Seconds			
	310 14 0.5 -40°C To +70°C -40°C To +85°C 260°C For 3 Seconds		

Notes:

1. 2mm below package base.

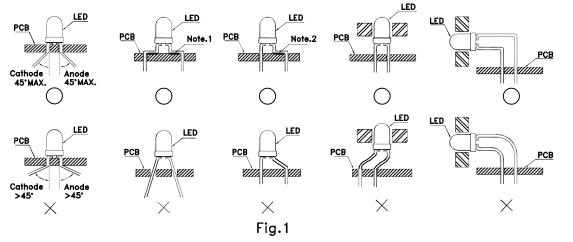
2. 5mm below package base.





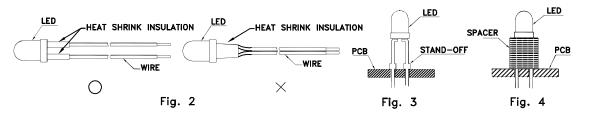
#### PRECAUTIONS

1. The lead pitch of the LED must match the pitch of the mounting holes on the PCB during component placement. Lead-forming may be required to insure the lead pitch matches the hole pitch. Refer to the figure below for proper lead forming procedures. (Fig. 1)



 $\bigcirc$  " Correct mounting method "imes" Incorrect mounting method

- When soldering wire to the LED, use individual heat-shrink tubing to insulate the exposed leads to prevent accidental contact short-circuit. (Fig.2)
- 3. Use stand-offs (Fig.3) or spacers (Fig.4) to securely position the LED above the PCB.



- 4. Maintain a minimum of 2mm clearance between the base of the LED lens and the first lead bend. (Fig. 5 and 6)
- 5. During lead forming, use tools or jigs to hold the leads securely so that the bending force will not be transmitted to the LED lens and its internal structures. Do not perform lead forming once the component has been mounted onto the PCB. (Fig. 7)

